

# MultiMedia Card EMI Filter Array with ESD Protection

#### **Features**

- Three channels of EMI filtering, each with ESD protection
- Two channels of ESD protection
- Flow-through routing for MMC interface
- ±15kV ESD protection (IEC 61000-4-2, contact discharge)
- ±30kV ESD protection (HBM)
- Greater than 30dB of attenuation at 1GHz
- Chip Scale Package features extremely low lead inductance for optimum filter and ESD performance
- 10-bump, 1.998mm x 1.458mm footprint Chip Scale Package (CSP)
- Available with OptiGuard<sup>™</sup> coating for improved reliability
- Lead-free version available

# **Applications**

- MultiMedia Card (MMC) slot in mobile handsets and other handheld devices such as digital cameras and MP3 players
- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers

## **Product Description**

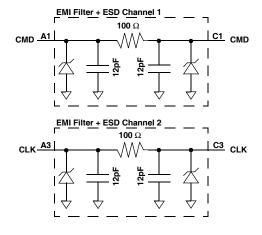
The CM1424 is an EMI filter array integrating 3 pi-filters (C-R-C) and 2 channels of ESD protection. The CM1424 has component values of  $12pF-100\Omega-12pF$ . The parts include avalanche-type ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes connected to the filter ports safely dissipate ESD strikes of  $\pm 15kV$ , beyond the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than  $\pm 30kV$ .

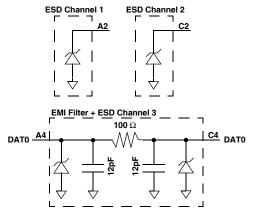
The ESD diodes on pins A2 and C2 safely dissipate ESD strikes of  $\pm 15 \text{kV}$ , well beyond the maximum requirement of the IEC 61000-4-2 international standard.

This device is particularly well-suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package and easy-to-use pin assignments. In particular, the CM1424 is ideal for EMI filtering and protecting data lines from ESD for the MultiMedia Card (MMC) slot in mobile handsets.

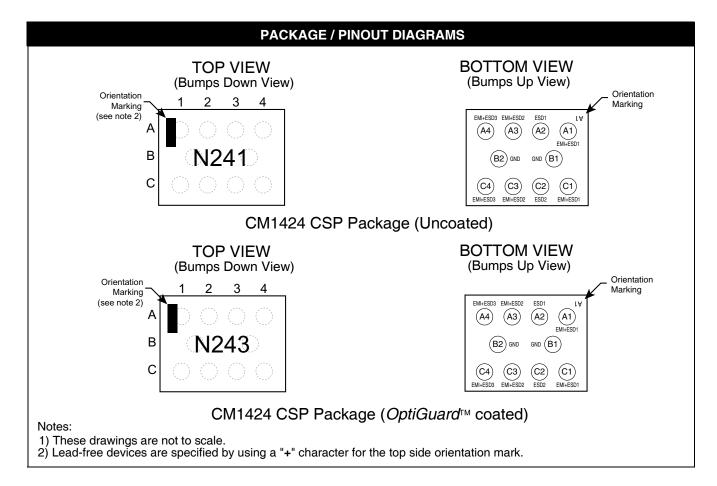
The CM1424 devices are optionally available with *Opti-Guard*<sup>™</sup> coating which results in improved reliability. The CM1424 is available in space-saving, low-profile, chip-scale packages with optional lead-free finishing.

## **Electrical Schematic**









PIN DESCRIPTIONS									
PIN(s)	NAME	DESCRIPTION		PIN(s)	NAME	DESCRIPTION			
A1	EMI+ESD1	CMD Filter Channel 1		C1	EMI+ESD1	CMD Filter Channel 1			
A2	ESD1	ESD Channel 1		C2	ESD2	ESD Channel 2			
A3	EMI+ESD2	CLK Filter Channel 2		C3	EMI+ESD2	CLK Filter Channel 2			
A4	EMI+ESD3	DAT0 Filter Channel 3		C4	EMI+ESD3	DAT0 Filter Channel 3			
B1-B2	GND	Device Ground							

# **Ordering Information**

PART NUMBERING INFORMATION										
			Standa	lard Finish Lead-free Finish <sup>2</sup>						
		No Coati	ing	<i>OptiGuard</i> <sup>™</sup> Coated		No Coating		<i>OptiGuard</i> <sup>™</sup> Coated		
Bumps	PKG	Ordering Part Number <sup>1</sup>	Part Marking	Ordering Part Number <sup>1</sup>	Part Marking	Ordering Part Number <sup>1</sup>	Part Marking	Ordering Part Number <sup>1</sup>	Part Marking	
10	CSP	CM1424-01CS	N241	CM1424-03CS	N243	CM1424-01CP	N241	CM1424-03CP	N243	

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

Note 2: Lead-free devices are specified by using a "+" character for the top side orientation mark.



# **Specifications**

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	RATING	UNITS					
Storage Temperature Range	-65 to +150	°C					
DC Power per Resistor	100	mW					
DC Package Power Rating	300	mW					

STANDARD OPERATING CONDITIONS						
PARAMETER	RATING	UNITS				
Operating Temperature Range	-40 to +85	°C				

	ELECTRICAL OPERATING CHARACTERISTICS <sup>1</sup>								
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS			
R	Resistance		80	100	120	Ω			
С	Capacitance	At 2.5V DC, 1MHz, 30mV AC	9	12	15	pF			
V <sub>DIODE</sub>	Diode Standoff Voltage	$I_{DIODE} = 10\mu A$		6.0		V			
I <sub>LEAK</sub>	Diode Leakage Current (reverse bias)	V <sub>DIODE</sub> = +3.3V		100	300	nA			
V <sub>SIG</sub>	Signal Clamp Voltage Positive Clamp Negative Clamp	I <sub>LOAD</sub> = 10mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V			
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	Notes 2 and 3	±30 ±15			kV kV			
R <sub>DYN</sub>	Dynamic Resistance Positive Negative			1.6 0.4		Ω Ω			
f <sub>C</sub>	Cut-off Frequency $Z_{SOURCE}$ =50 $\Omega$ , $Z_{LOAD}$ =50 $\Omega$	Channel R=100Ω, Channel C=12pF		157		MHz			

Note 1:  $T_A=25$ °C unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: These parameters are guaranteed by design and characterization.



## **Performance Information**

Typical Filter Performance (T<sub>A</sub>=25°C, DC Bias=0V, 50 Ohm Environment)

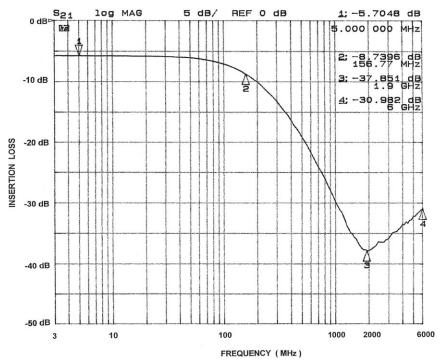


Figure 1. Insertion Loss VS. Frequency (A1-C1 to GND B1)

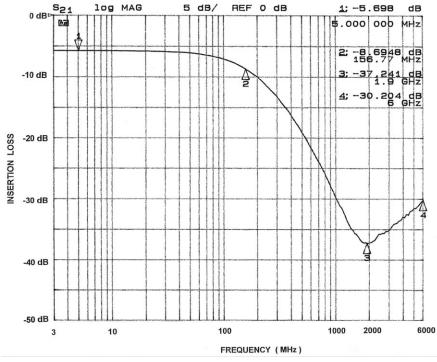


Figure 2. Insertion Loss VS. Frequency (A3-C3 to GND B2)



# Performance Information (cont'd)

Typical Filter Performance (T<sub>A</sub>=25°C, DC Bias=0V, 50 Ohm Environment)

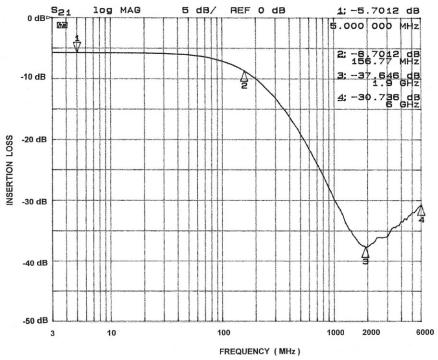


Figure 3. Insertion Loss VS. Frequency (A4-C4 to GND B2)

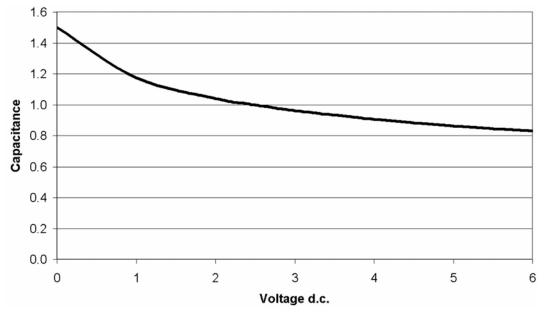


Figure 4. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5VDC and 25°C)



## **Application Information**

Refer to Application Note AP-217, "The Chip Scale Package", for a detailed description of Chip Scale Packages offered by California Micro Devices.

PRINTED CIRCUIT BOARD RECOMMENDATIONS						
PARAMETER	VALUE					
Pad Size on PCB	0.275mm					
Pad Shape	Round					
Pad Definition	Non-Solder Mask defined pads					
Solder Mask Opening	0.325mm Round					
Solder Stencil Thickness	0.125mm - 0.150mm					
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.330mm Round					
Solder Flux Ratio	50/50 by volume					
Solder Paste Type	No Clean					
Pad Protective Finish	OSP (Entek Cu Plus 106A)					
Tolerance — Edge To Corner Ball	±50μm					
Solder Ball Side Coplanarity	<u>+</u> 20μm					
Maximum Dwell Time Above Liquidous (183°C)	60 seconds					
Maximum Soldering Temperature for a Eutectic Device using Eutectic Solder Paste	240°C					
Maximum Soldering Temperature for a Lead-free Device using Lead-free Solder Paste	260°C					

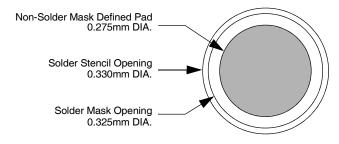


Figure 5. Recommended Non-Solder Mask Defined Pad Illustration

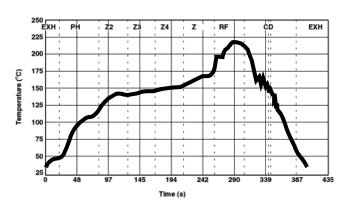


Figure 6. Eutectic (SnPb) Solder **Ball Reflow Profile** 

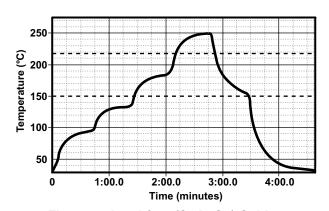


Figure 7. Lead-free (SnAgCu) Solder **Ball Reflow Profile** 



# **Mechanical Details (cont'd)**

CM1424 devices are supplied in custom Chip Scale Packages (CSP) and are available with optional Opti-Guard<sup>™</sup> coating.

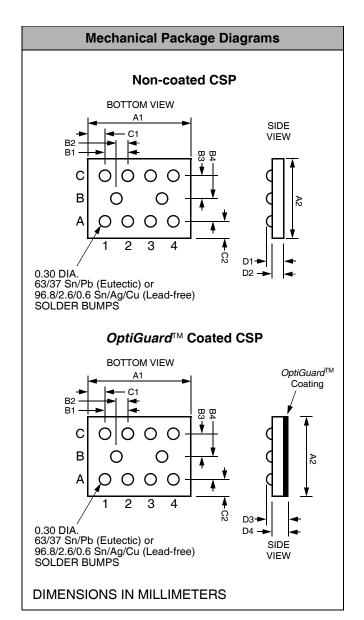
#### **CM1424 Mechanical Specifications**

The package dimensions for the CM1424 are presented below.

PACKAGE DIMENSIONS								
Pack	age	Custom CSP						
Bum	ıps	10						
Dim	M	lillimete	rs		Inches			
Dilli	Min	Nom	Max	Min	Nom	Max		
A1	1.953	1.998	2.043	0.0769	0.0787	0.0804		
A2	1.413	1.458	1.503	0.0556	0.0574	0.0592		
B1	0.495	0.500	0.505	0.0195	0.0197	0.0199		
B2	0.245	0.250	0.255	0.0096	0.0098	0.0100		
В3	0.430	0.435 0.440		0.0169	0.0171	0.0173		
B4	0.430	0.435	0.440	0.0169	0.0171	0.0173		
C1	0.199	0.249	0.299	0.0078	0.0098	0.0118		
C2	0.244	0.294	0.344	0.0096	0.0116	0.0135		
D1 <sup>1</sup>	0.562	0.606	0.650	0.0221	0.0239	0.0256		
D2 <sup>1</sup>	0.356	0.381	0.406	0.0140	0.0150	0.0160		
D3 <sup>2</sup>	0.575	0.644	0.714	0.0226	0.0254	0.0281		
D4 <sup>2</sup>	0.368	0.419	0.470	0.0145	0.0165	0.0185		
# per tape and reel		3500 pieces						
	Controlling dimension: millimeters							

Note 1: Applies to uncoated devices only.

Note 2: Applies to *OptiGuard*™ (coated) devices only.



**Package Dimensions for** CM1424 Chip Scale Package



# Mechanical Details (cont'd)

### **CSP Tape and Reel Specifications**

PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B <sub>0</sub> X A <sub>0</sub> X K <sub>0</sub>	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P <sub>0</sub>	P <sub>1</sub>
CM1424-01	1.998x 1.458 x 0.606	2.29 x 1.6 x 0.81	8mm	178mm (7")	3500	4mm	4mm
CM1424-03	1.998 x 1.458 x 0.644	2.29 x 1.6 x 0.81	8mm	178mm (7")	3500	4mm	4mm

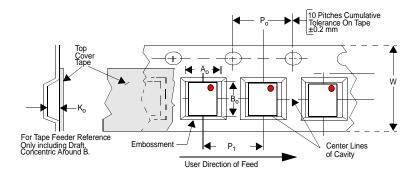


Figure 8. Tape and Reel Mechanical Data